SQJ122ELP

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RoHS

COMPLIANT

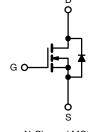
Automotive N-Channel 30 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	30			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.00325			
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.00500			
I _D (A) ^e	101			
Configuration	Single			

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Q_{gd}/Q_{gs} ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK [®] SO-8L
Lead (Pb)-free and halogen-free	SQJ122ELP (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current ^e	T _C = 25 °C	1	101		
	T _C = 125 °C	I _D	58		
Continuous source current (diode conduction) e		ا _S	55	А	
Pulsed drain current ^a		I _{DM}	350		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	23		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	26	mJ	
Maximum power dissipation ^{a, e}	T _C = 25 °C	D	60	W	
	T _C = 125 °C	P _D	20		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260	C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^b	R _{thJA}	42	°C/W
nction-to-case (drain) ^d		R _{thJC}	2.5	C/ W

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. As per JESD51-14

e. Values based on R_{thJC} and T_C of 25 °C.Actual values achievable will be dependent on the thermal characteristics of the complete system

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PARAMETER	SYMBOL	herwise noted) TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		1					I
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		30	-	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$		1.5	2.0	2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = 30 V	-	-	1	
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 175 °C	-	-	250	
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	30	-	-	Α
		V _{GS} = 10 V	I _D = 15 A	-	0.0027	0.00325	
Ducin actures on state registeres a	Б	V _{GS} = 10 V	I _D = 15 A, T _J = 125 °C	-	-	0.0050	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 15 A, T _J = 175 °C	-	-	0.0060	Ω
		$V_{GS} = 4.5 V$	I _D = 15 A	-	0.0040	0.0050	
Forward transconductance b	9 _{fs}	V _{DS}	= 15 V, I _D = 40 A	-	110	-	S
Dynamic ^b		•					•
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1998	2798	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	735	1029	
Reverse transfer capacitance	C _{rss}			-	108	152	
Total gate charge ^c	Qg			-	33	51	
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $V_{DS} = 15 \text{ V}, I_D = 6 \text{ A}$	-	6	-	nC
Gate-drain charge ^c	Q _{gd}			-	6	-	
Gate resistance	Rg	f = 1 MHz		1.2	3.02	4.8	Ω
Turn-on delay time ^c	t _{d(on)}			-	11	17	
Rise time ^c	tr	V _{DD}	= 15 V, R _L = 1 Ω	-	5	9	20
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 6 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	28	42	- ns
Fall time ^c	t _f			-	9	14	
Source-Drain Diode Ratings and Cha	aracteristics ^b						
Pulsed current ^a	I _{SM}			-	-	220	Α
Forward voltage	V _{SD}	I _F = 15 A, V _{GS} = 0 V		-	-	1.1	V
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs		-	33	66	ns
Body diode reverse recovery charge	Q _{rr}			-	16	34	nC
Reverse recovery fall time	t _a			-	13	-	
Reverse recovery rise time	t _b			-	21	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-0.85	-	А

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

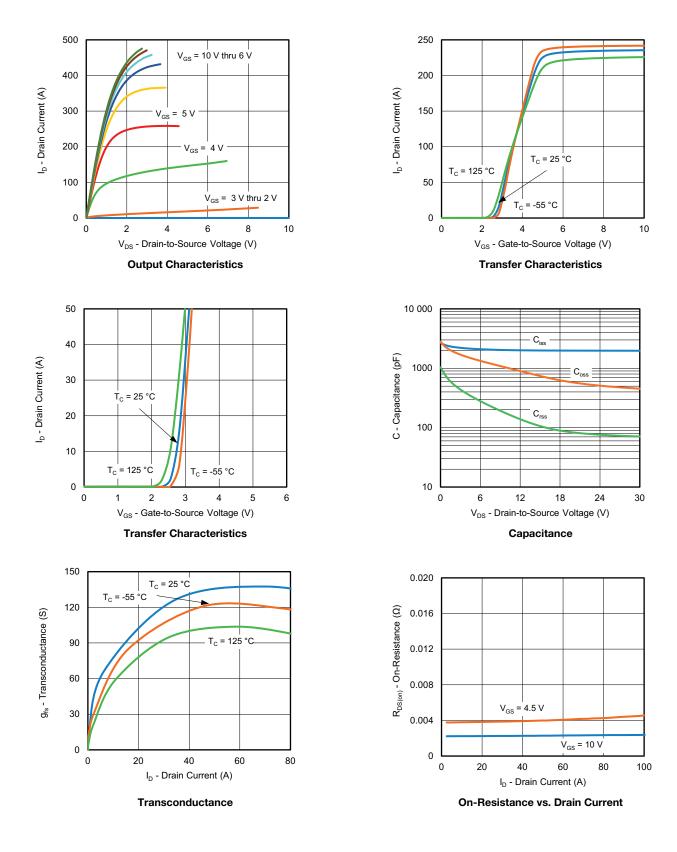
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



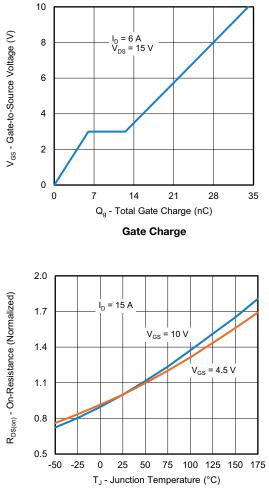
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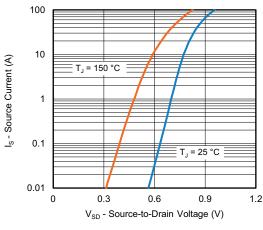


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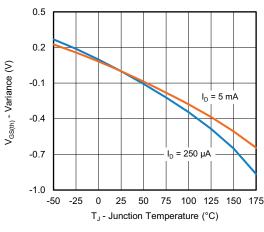
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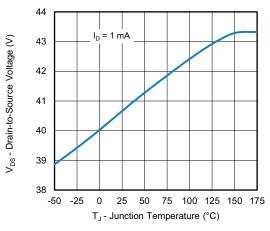
On-Resistance vs. Junction Temperature



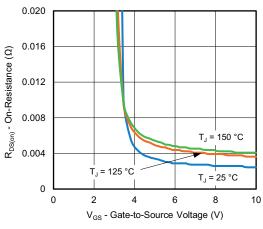
Source Drain Diode Forward Voltage



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Gate-to Source Voltage

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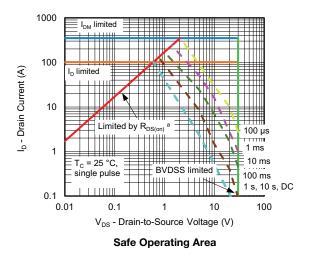
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Note

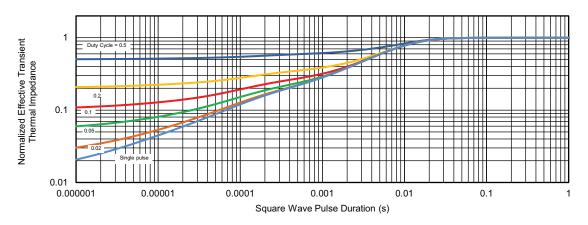
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



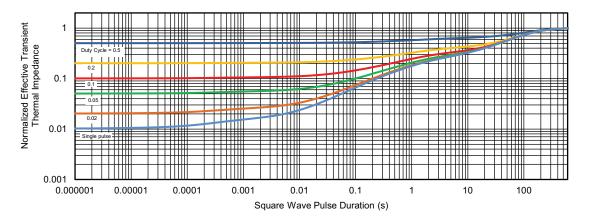
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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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